## onsemi

MARKING DIAGRAMS

### TinyLogic UHS Unbuffered Inverter

### NC7SZU04

#### Description

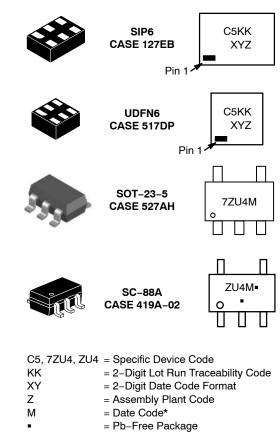
The NC7SZU04 is a single unbuffered inverter from **onsemi**'s Ultra–High Speed series of TinyLogic. The special purpose unbuffered circuit design is primarily intended for crystal oscillator or analog applications. The device is fabricated with advanced CMOS technology to achieve ultra–high speed with high output drive while maintaining low static power dissipation over a broad  $V_{CC}$  operating range. The device is specified to operate over the 1.65 V to 5.5 V  $V_{CC}$  range.

#### Features

- Unbuffered for Crystal Oscillator and Analog Applications
- Balanced Output Drive:  $\pm 32$  mA at 4.5 V V<sub>CC</sub>
- Balanced Output Drive: ±16 mA at 4.5 V V<sub>CC</sub> (NC7SZU04P5X-L22057)
- Broad V<sub>CC</sub> Operating Range: 1.65 V to 5.5 V
- Matches Performance of LCX Operated at 3.3 V V<sub>CC</sub>
- Low Quiescent Power:  $I_{CC} < 2 \mu A$ ,  $V_{CC} = 5.5 V$ ,  $T_A = 25^{\circ}C$
- Ultra-Small MicroPak<sup>TM</sup> Packages
- Space-Saving SOT-23-5 and SC-88A Packages
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



Figure 1. Logic Symbol



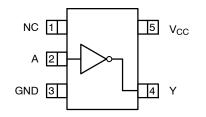
(Note: Microdot may be in either location)

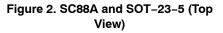
\*Date Code orientation and/or position may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 7 of this data sheet.

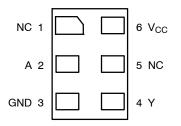
#### **Pin Configurations**





#### **PIN DEFINITIONS**

Pin # SC-88A / SOT-23-5	Pin # MicroPak	Name	Description
1	1, 5	NC	No Connect
2	2	А	Input
3	3	GND	Ground
4	4	Y	Output
5	6	V <sub>CC</sub>	Supply Voltage



#### Figure 3. MicroPak (Top Through View)

#### **FUNCTION TABLE**

Inputs	Output
A	Y
L	Н
Н	L

H = HIGH Logic Level L = LOW Logic Level

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter		Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		-0.5	6.5	V
V <sub>IN</sub>	DC Input Voltage		-0.5	6.5	V
V <sub>OUT</sub>	DC Output Voltage		-0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> < 0 V	-	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> < 0 V	-	-50	mA
	V <sub>OUT</sub> > V <sub>CC</sub>	-	+50		
I <sub>OUT</sub>	DC Output Current		-	±50	mA
$I_{CC} \text{ or } I_{GND}$	DC V <sub>CC</sub> or Ground Current		-	±50	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under Bias		-	+150	°C
ΤL	Junction Lead Temperature (Sole	dering, 10 Seconds)	-	+260	°C
PD	Power Dissipation in Still Air	SOT-23-5	-	390	mW
		SC-88A	-	332	
		MicroPak-6	-	812	
		MicroPak2™–6	-	812	
ESD	Human Body Model, JEDEC: JE	SD22-A114	-	4000	V
	Charge Device Model, JEDEC:	ESD22-C101	-	2000	1

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage Operating		1.65	5.5	V
	Supply Voltage Data Retention		1.50	5.5	
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
$\theta_{JA}$	Thermal Resistance	SOT-23-5	-	320	°C/W
		SC-88A	-	377	
		MicroPak-6	-	154	
		MicroPak2-6	-	154	1

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 1. Unused inputs must be held HIGH or LOW. They may not float.

#### NC7SZU04

#### DC ELECTRICAL CHARACTERISTICS

				Т,	<b>م = +25</b> °	°C	T <sub>A</sub> = -40	to +85°C	
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Тур	Max	Min	Max	Unit
VIH	HIGH Level Input		1.8 to 2.7	0.85 V <sub>CC</sub>	-	-	0.85 V <sub>CC</sub>	-	V
	Voltage		3.0 to 5.5	0.80 V <sub>CC</sub>	-	-	0.80 V <sub>CC</sub>	-	
V <sub>IL</sub>	LOW Level Input		1.8 to 2.7	-	-	0.15 V <sub>CC</sub>	-	0.15 V <sub>CC</sub>	V
	Voltage		3.0 to 5.5	-	-	0.20 V <sub>CC</sub>	-	0.20 V <sub>CC</sub>	
V <sub>OH</sub>	High-Level Output Voltage		1.65 to 5.5 1.65 2.3 2.7 3.0 3.0 4.5	V <sub>CC</sub> - 0.1 1.29 1.9 2.2 2.4 2.3 3.8	V <sub>CC</sub> 1.4 2.1 2.4 2.7 2.5 4.0		V <sub>CC</sub> - 0.1 1.29 1.9 2.2 2.4 2.3 3.8		V
V <sub>OL</sub>	Low-Level Output Voltage		1.65 to 5.5 1.65 2.3 2.7 3.0 3.0 4.5	- - - - -	- 0.08 0.2 0.22 0.28 0.38 0.38	0.1 0.24 0.3 0.4 0.4 0.55 0.55	- - - - -	0.1 0.24 0.3 0.4 0.4 0.55 0.55	V
I <sub>IN</sub>	Input Leakage Current	V <sub>IN</sub> = 5.5 V, GND	1.65 to 5.5	-	-	±1	-	±10	μΑ
ICC	Quiescent Supply Current	V <sub>IN</sub> = 5.5 V, GND	1.65 to 5.5	-	-	2	-	20	μΑ
I <sub>CCPEAK</sub>	Peak Supply	V <sub>OUT</sub> = Open, V <sub>IN</sub> = Adjust	1.8	-	2	-	-	-	mA
	Current in Analog Operation	for Peak I <sub>CC</sub> Current	2.5	-	4	-	-	_	
			3.3	-	10	-	-	-	
			5.0	-	30	-	-	-	

#### NC7SZU04

## DC ELECTRICAL CHARACTERISTICS (NC7SZU04P5X-L22057, NC7SZU04L6X-L22175, NC7SZU04FHX-L22175)

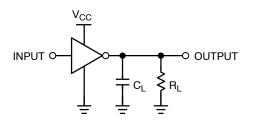
					T,	T <sub>A</sub> = +25°C			to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Cone	ditions	Min	Тур	Мах	Min	Max	Unit
V <sub>IH</sub>		1.8 to 2.7			0.85 V <sub>CC</sub>	-	-	0.85 V <sub>CC</sub>	-	V
	Voltage	3.0 to 5.5			0.80 V <sub>CC</sub>	-	-	0.80 V <sub>CC</sub>	_	1
VIL	LOW Level Input	1.8 to 2.7			-	-	0.15 V <sub>CC</sub>	-	0.15 V <sub>CC</sub>	V
	Voltage	3.0 to 5.5			-	-	0.20 V <sub>CC</sub>	-	0.20 V <sub>CC</sub>	1
V <sub>OH</sub>	HIGH Level	1.65	V <sub>IN</sub> = V <sub>IL</sub> , I <sub>OI</sub>	<sub>H</sub> = −100 μA	1.55	1.65	-	1.55	_	V
	Output Voltage	1.80			1.60	1.80	-	1.60	_	1
		2.30			2.10	2.30	-	2.10	_	
		3.00			2.70	3.00	-	2.70	_	
		4.50			4.00	4.40	-	4.00	_	
		1.65	V <sub>IN</sub> = GND	I <sub>OH</sub> = -4 mA	1.29	1.52	-	1.29	-	1
		2.30		I <sub>OH</sub> = -4 mA	1.90	2.14	-	1.90	-	-
		3.00		I <sub>OH</sub> = -8 mA	2.40	2.75	_	2.40	-	
	3.00		$I_{OH} = -12 \text{ mA}$	2.30	2.61	_	2.30	-		
	4.50		$I_{OH} = -16 \text{ mA}$	3.80	4.13	_	3.80	-		
V <sub>OL</sub> LOW Level	1.65	$V_{IN} = V_{IH}, I_O$	$V_{IN} = V_{IH}, I_{OL} = 100 \ \mu A$		0.00	0.10	-	0.10	V	
	Output Voltage	1.80			_	0.00	0.20	-	0.20	
		2.30			-	0.00	0.20	-	0.20	
		3.00			-	0.00	0.30	-	0.30	
		4.50			-	0.00	0.50	-	0.50	
		1.65	$V_{IN} = V_{CC}$	I <sub>OL</sub> = 4 mA	-	0.80	0.24	-	0.24	
		2.30		I <sub>OL</sub> = 4 mA	-	0.10	0.30	-	0.30	
		3.00		I <sub>OL</sub> = 8 mA	-	0.17	0.40	-	0.40	
		3.00		I <sub>OL</sub> = 12 mA	-	0.25	0.55	-	0.55	
		4.50		I <sub>OL</sub> = 16 mA	-	0.226	0.55	-	0.55	
I <sub>IN</sub>	Input Leakage Current	1.65 to 5.5	V <sub>IN</sub> = 5.5 V, 0	GND	-	-	±1	-	±10	μA
I <sub>CC</sub>	Quiescent Supply Current	1.65 to 5.50	V <sub>IN</sub> = 5.5 V, 0	GND	-	-	2	-	20	μA
I <sub>CCPEAK</sub>	Peak Supply	1.8	V <sub>OUT</sub> = Oper	n, V <sub>IN</sub> = Adjust	-	2	-	-	_	mA
	Current in Analog Operation	2.5	for Peak I <sub>CC</sub>	Current	-	4	-	-	_	1
		3.3			-	10	-	-	-	1
		5.0	1		_	30	_	-	_	1

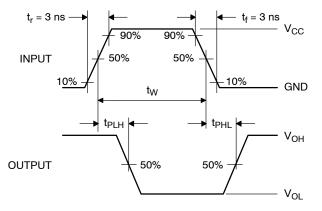
#### NC7SZU04

#### **AC ELECTRICAL CHARACTERISTICS**

				T <sub>A</sub> = +25°C			T <sub>A</sub> = −40 to +85°C		
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay	1.65	C <sub>L</sub> = 15 pF,	_	-	11.7	-	12.1	ns
	(Figure 4, 5)	1.80	R <sub>L</sub> = 1 MΩ	_	-	8.5	-	9.0	
		2.50 ±0.20		_	-	6.2	-	6.5	
	$3.30\pm0.30$		_	-	4.5	-	4.8		
		5.00 ±0.50		_	-	3.9	-	4.1	
		$3.30 \pm 0.30$	C <sub>L</sub> = 50 pF,	-	-	6.0	-	6.5	
		5.00 ±0.50	R <sub>L</sub> = 500 Ω	_	_	5.0	-	5.5	
C <sub>IN</sub>	Input Capacitance	0.00		-	4.5	-	-	-	pF
C <sub>PD</sub>	Power Dissipation Capacitance	3.30		-	6.3	-	-	-	pF
	(Note 2) (Figure 6)	5.00		_	9.5	-	-	-	

 C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:  $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC} static).$ 



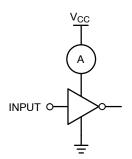


NOTE:

- 3. CL includes load and stray capacitance. 4. Input PRR = 1.0 MHz;  $t_W$  = 500 ns







NOTE:

5. When operating the NC7SZU04's unbuffered output stage in its linear range, as in oscillator applications, care must be taken to observe maximum power rating for the device and package. The high drive nature of the design of the output stage results in substantial simultaneous conduction currents when the stage is in the linear region. See the I<sub>CCPEAK</sub> specification in the DC Electrical Characteristics table. 6. Input = AC Waveform; t<sub>r</sub> = t<sub>f</sub> = 1.8 ns; PRR = Variable; Duty Cycle = 50%.

Figure 6. I<sub>CCD</sub> Test Circuit

#### **ORDERING INFORMATION**

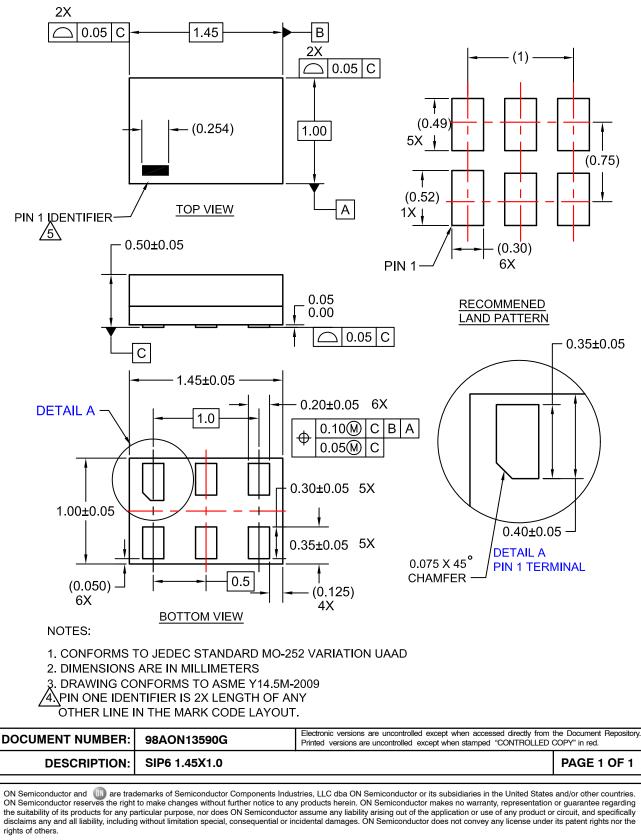
Part Number	Top Mark	Packages	Shipping <sup>†</sup>	
NC7SZU04M5X	7ZU4	SOT-23-5	3000 / Tape & Reel	
NC7SZU04M5X-L22090	7ZU4	SOT-23-5	3000 / Tape & Reel	
NC7SZU04P5X	ZU4	SC-88A	3000 / Tape & Reel	
NC7SZU04P5X-L22057	ZU4	SC-88A	3000 / Tape & Reel	
NC7SZU04L6X	C5	SIP6, MicroPak	5000 / Tape & Reel	
NC7SZU04L6X-L22175	C5	SIP6, MicroPak	5000 / Tape & Reel	
NC7SZU04FHX	C5	UDFN6, MicroPak2	5000 / Tape & Reel	
NC7SZU04FHX-L22175	C5	UDFN6, MicroPak2	5000 / Tape & Reel	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



SIP6 1.45X1.0 CASE 127EB ISSUE O

DATE 31 AUG 2016



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# **NSEM**

DATE 11 APR 2023

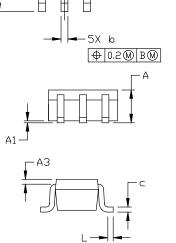


SCALE 2:1

#### SC-88A (SC-70-5/SOT-353) CASE 419A-02 **ISSUE M**

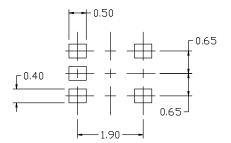
NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 419A-01 DBSOLETE, NEW STANDARD 419A-02 З.
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, 4. PROTRUSIONS, OR GATE BURRS.MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.



e

F1



#### RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

DIM	MILLIMETERS					
ויונע	MIN.	NDM.	MAX,			
A	0.80	0.95	1.10			
A1			0.10			
A3	0.20 REF					
b	0.10	0.20	0,30			
C	0.10		0,25			
D	1.80	2.00	5.20			
E	2.00	2.10	5.20			
E1	1.15	1.25	1.35			
e		0.65 BSI	C			
L	0.10	0.15	0.30			

#### **GENERIC MARKING**





\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code

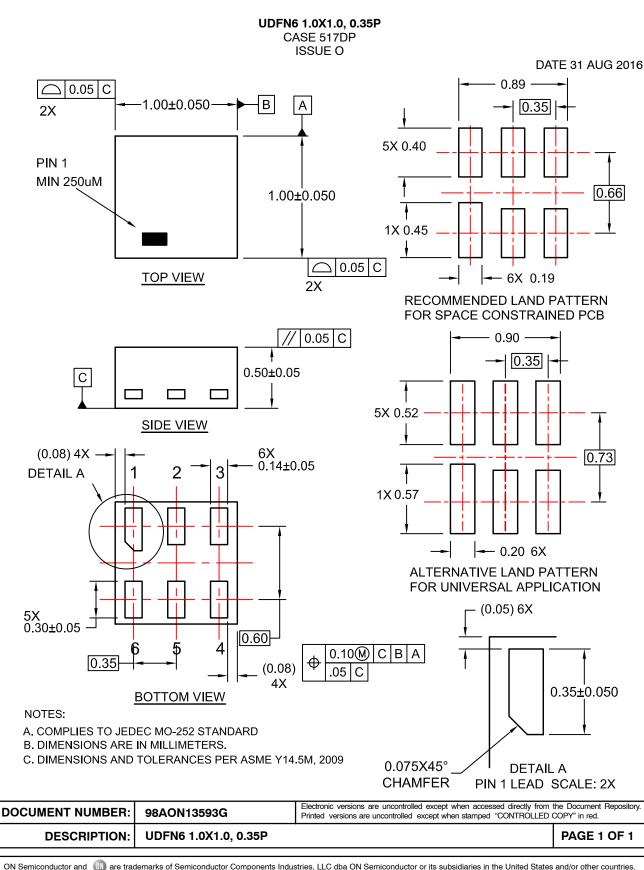
Μ = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

3. EMITTER 1 4. COLLECTOR 5. COLLECTOR 2/BASE	3. BASE 4. COLLECTOR 5. COLLECTOR 98ASB42984B		style callout. If style type is not calle out in the datasheet refer to the devi datasheet pinout or pin assignment. pt when accessed directly from the Document Repo when stamped "CONTROLLED COPY" in red.	
OCUMENT NUMBER:	98ASB42984B			lepository.

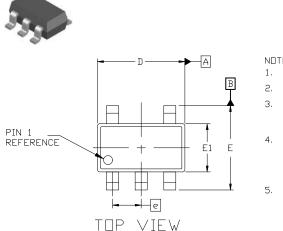
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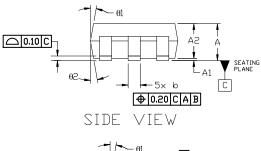


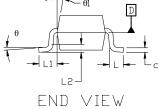


DATE 09 JUN 2021

NDTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 19894
- CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.25 PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM D.
- DIMENSION 'b' DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08mm TOTAL IN EXCESS OF THE 'b' DIMENSION AT MAXIMUM MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07mm.





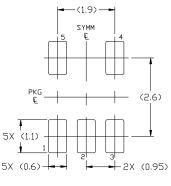
GENERIC **MARKING DIAGRAM\*** 



XXX = Specific Device Code = Date Code М

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

	MIL	LIMETER	S			
DIM	MIN.	NDM.	MAX.			
Α	0.90 —		1.45			
A1	0.00	—	0.15			
A2	0.90	1.15	1.30			
b	0.30	—	0.50			
С	0.08	_	0.22			
D	2.90 BSC					
E	2.80 BSC					
E1	1.60 BSC					
e	0.95 BSC					
L	0.30	0.45	0.60			
L1	0	.60 REF				
L2	0	.25 REF				
θ	0*	4°	8*			
01	0*	10°	15°			
02	0°	10°	15°			



#### RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON34320E	98AON34320E Electronic versions are uncontrolled except when accessed directly from the Document Rep Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				
DESCRIPTION:	SOT–23, 5 LEAD		PAGE 1 OF 1			

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